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CLAIMS

- 1. (CANCELLED) An apparatus, comprising:
- a first disc member;
- a main body, in communication with said first disc member; and
- a second disc member;

wherein said main body contains at least one environmental sensor.

- 2. (NEW) A monitoring device for silicon wafer transfer pods, comprising:
 - a top part;
 - a cylinder in communication with said top part;
 - a bottom part in communication with said cylinder;
 - a control unit in communication with said cylinder; and
 - a wireless link in communication with said control unit.
- 3. (NEW) The monitoring device of claim 2 wherein said top part and said bottom part are the same circular shape as the silicon wafer transfer pods.
- 4. (NEW) The monitoring device of claim 2 wherein said top part and said bottom part are configured to fit inside the silicon wafer transfer pods.
- 5. (NEW) The monitoring device of claim 2 wherein said top part, said bottom part and said cylinder accompany silicon wafers in the transfer pods throughout a manufacturing process.
- 6. (NEW) The monitoring device of claim 2 wherein said cylinder is configured to draw in air to a conventional particle detector.

- 7. (NEW) The monitoring device of claim 2 wherein said control unit is configured to detect any change in the environment of the silicon wafer transfer pods.
- 8. (NEW) The monitoring device of claim 2 wherein said wireless link is configured to display warning, flow, or failure status lights when there is a change in the environment of the silicon wafer transfer pods.
- 9. (NEW) The monitoring device of claim 2 wherein said cylinder houses sensor equipment.
- 10. (NEW) A monitoring device for silicon wafer transfer pods, comprising:

two discs;

at least one sample tube between said discs;

wherein said discs and said at least one sample tube are configured to fit inside a silicon wafer transport pod for monitoring particles.